

Title (en)

SENSOR ARRANGEMENT IN A HEAT PUMP SYSTEM

Title (de)

SENSORANORDNUNG IN EINER WÄRMEPUMPE

Title (fr)

AGENCEMENT DE CAPTEUR DANS UN SYSTÈME DE POMPE À CHALEUR

Publication

**EP 3196569 A1 20170726 (EN)**

Application

**EP 16152194 A 20160121**

Priority

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Abstract (en)

The present invention discloses a heat pump system including a refrigerant circuit having a compressor, a first heat exchanger downstream of the compressor for operating as a condenser in a heating mode and operating as an evaporator in a cooling mode, a throttling device downstream of the first heat exchanger, and a second heat exchanger downstream of the throttling device for operating as an evaporator in the heating mode and operating as a condenser in the cooling mode. A reversing valve is disposed in the refrigerant circuit between the compressor and the first/second heat exchanger for selectively reversing the refrigerant flow therein. A sensor combination for being used to calculate a present super-heating degree, wherein the sensor combination includes a temperature sensor for detecting a temperature of the refrigerant after leaving from the second heat exchanger and before entering the reversing valve and a second sensor for being used to measure a saturated temperature of the refrigerant at a low pressure side. In this way, the heat pump system can avoid super-heating degree instabilities caused by the reversing valve, thereby improving its performance and efficiency.

IPC 8 full level

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Citation (search report)

- [XI] EP 1647783 A2 20060419 - MITSUBISHI ELECTRIC CORP [JP]
- [XI] EP 2806233 A1 20141126 - DAIKIN IND LTD [JP]
- [XI] EP 2261580 A1 20101215 - DAIKIN IND LTD [JP]
- [XI] EP 2270405 A1 20110105 - DAIKIN IND LTD [JP]
- [XI] US 2007033955 A1 20070215 - LUO RAN [US], et al

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